

PRODUCT SPECIFICATION

Part Number

PG12864E1-O Series

CUSTOMER	
CUSTOMER PART NUMBER	
DESCRIPTION	
APPROVED BY	
DATE	

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Rev.	Comments	Page	Date	
	Preliminary Specification was first issued.	All	7/4'14	



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1. FUNCTIONS & FEATURES

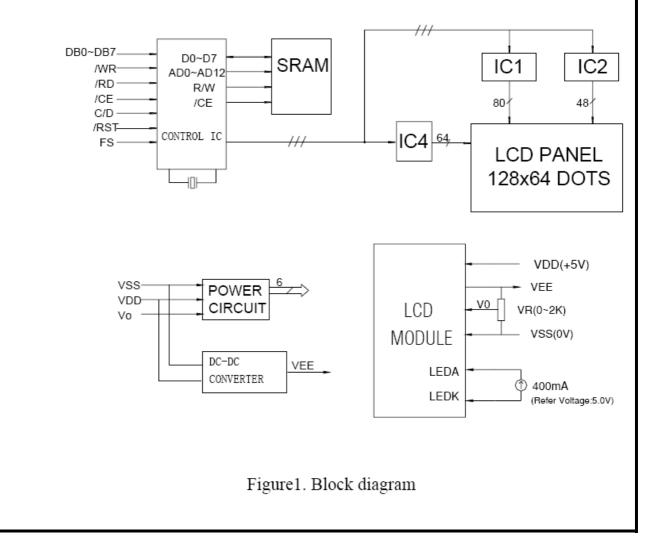
- 1.1. Format
- 1.2. LCD mode
- 1.3. Viewing direction
- 1.4. Driving scheme
- 1.5. Power supply voltage (V_{DD})
- 1.6. LCD driving voltage(Vop)
- 1.7. Operation temp
- 1.8. Storage temp
- 1.9. Backlight color
- 1.10. RoHS standard

2. MECHANICAL SPECIFICATIONS

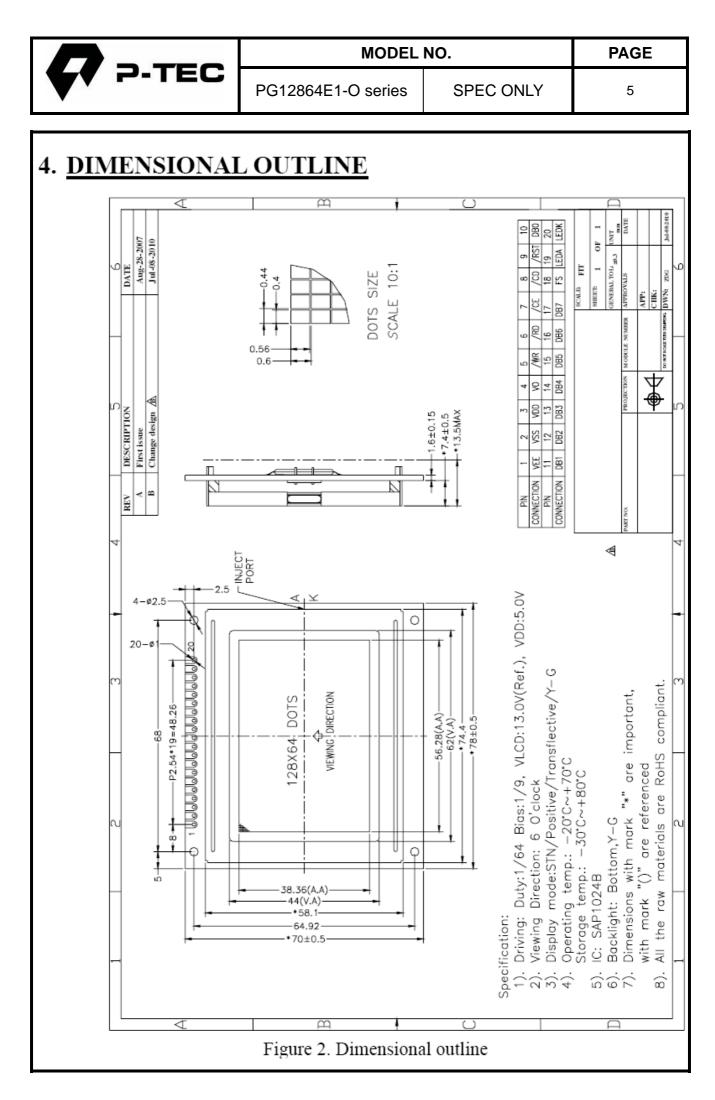
- 2.1. Module size
- 2.2. Viewing area
- 2.3. Dot pitch
- 2.4. Dot size
- 2.5. Weight

- : 78.0mm(L)*70.0mm(W)*13.5max mm(H) : 62.0mm(L)*44.0mm(W)
- : 0.44 mm(L)*0.60 mm(W)
- : 0.40mm(L)*0.56mm(W)
- : Approx.

3. BLOCK DIAGRAM



- : 128x64dots : STN /Positi
- : STN /Positive / Transflective/ Yellow-green Mode
- : 6 o'clock
- : 1/64 Duty , 1/9 Bias
- : 5.0V
- : 13V
- : **-**20~70℃
- : **-**30~80℃
- : Bottom Yellow-green





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5. <u>PIN DESCRIPTION</u>

No.	Symbol	Function
1	VEE	Negative voltage output;
2	VSS	GND
3	VDD	Power supply for Logic(+5.0V)
4	VO	Supply voltage for LCD drive
5	/WR	Write signal.
6	/RD	Read signal
7	/CE	Chip enable signal
8	C/D	Data or instruction select signal(H: data register; L: instruction register)
9	/RST	Reset signal
10~17	DB0~DB7	Data bus lines
18	FS	Font selection
19	LEDA	Power supply for Backlight (+5.0V)
20	LEDK	Power supply for Backlight (0V)

6. MAXIMUM ABSOLUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	Vdd	-0.3	7.0	V
Supply Voltage for LCD	V0	Vdd-15.0	VDD+0.3	V
Input Voltage	Vin	-0.3	VDD+0.3	V
Supply Current for Backlight	I (Ta = 25°C)		400+400*20%	mA
Reverse Voltage for Backlight	V (Ta = 25°C)		5.0	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-30	80	°C

7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD-VSS	$Ta = 25^{\circ}C$	4.75	5.0	5.25	V
Input High Voltage	Vih	$Ta = 25^{\circ}C$	0.7Vdd		Vdd	V
Input Low Voltage	Vil	$Ta = 25^{\circ}C$	0		0.3Vdd	V
Output High Voltage	Vон	$Ta = 25^{\circ}C$	2.4			V
Output Low Voltage	Vol	$Ta = 25^{\circ}C$			0.4	V
Supply Current	Idd	$Ta = 25^{\circ}C$		15	20	mA



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8.BACKLIGHT CHARACTERISTICS

 $Ta = 25^{\circ}C$

= 25°C							
Item	Symbol	Condition	Min	Тур	Max	Unit	
Forward Voltage	VF	IF=400mA	3.85	4.05	4.25	V	
Reverse Current	IR	VR=5.0V			100	uA	
Wave length	λρ	IF=400mA		570		nm	
Luminous Intensity (Without LCD)	IV	IF=400mA	151	216		Cd/m ²	
Color		Yellow-green					

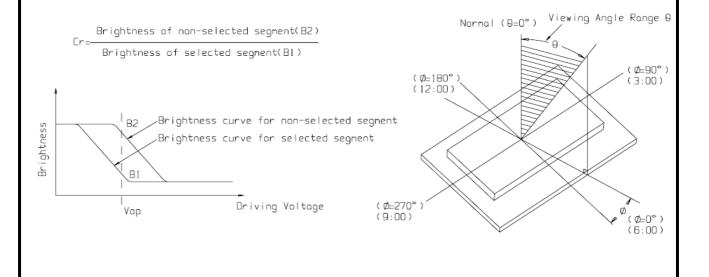
Note:

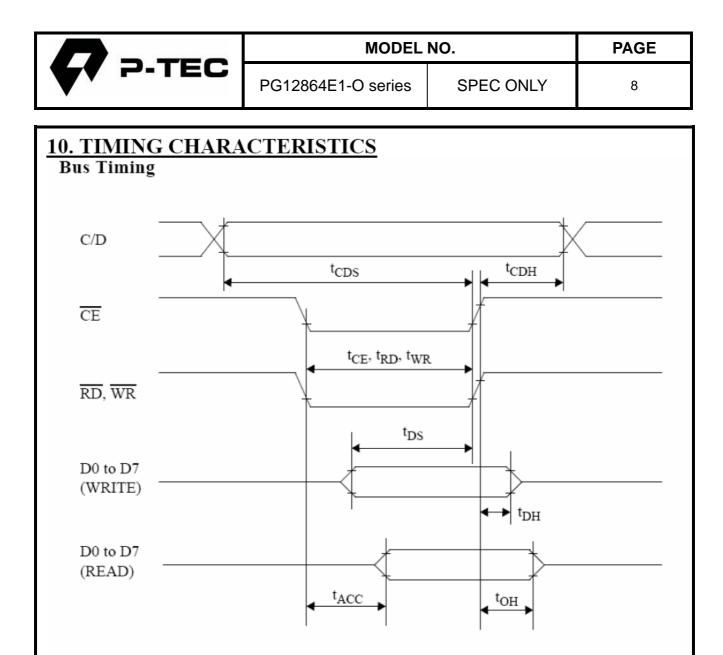
when the temperature exceed 25 °C, the approved current decrease rate for Backlight change the temperature increase is: -0.36x40mA/°C (below 25 °C, the current refer to constant, who would not change with temperature).

9. ELECTRO-OPTICAL CHARACTERISTICS

 $(VDD=5.0V, Ta = 25^{\circ}C)$

Item	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage		Ta =-20°C	13.7	14.0	14.3	
Operating Voltage Of LCD	Vop	$Ta = 25^{\circ}C$	13.3	13.6	13.9	V
OI LCD		$Ta = 70^{\circ}C$	12.9	13.2	13.5	
Desnance time	Tr	$Ta = 25^{\circ}C$		185		ms
Response time	Tf	1a - 25 C		200		ms
Contrast	Cr	$Ta = 25^{\circ}C$		4.0		
T 7' ' 1	θ	Cr≥2	-40		+40	deg
Viewing angle range	Φ	0≥2	-40		+40	deg





Test Conditions(Unless Otherwise Noted, VDD = $5.0\pm 10\%$, Vss = 0V, Ta=-20 to $75^{\circ}C$)

Item	Symbol	Test Conditions	Min	Max	Unit
C/D Set-up Time	t _{CDS}	_	100	-	ns
C/DHold Time	t _{CDH}	_	10	_	ns
CE, RD, WR Pulse Width	$t_{\rm CE},t_{\rm RD},t_{\rm WR}$	_	80	-	ns
Data Set-up Time	t _{DS}	-	80	_	ns
Data Hold Time	^t DH	_	40	_	ns
Access Time	t _{ACC}	_	_	150	ns
Output Hold Time	t _{OH}	_	10	50	ns



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11.	CONTROL	AND DISPLAY	COMMAND

Commands	D7	D6	D5	D4	D3	D2	D1	D0	Description	Execute Time
Pointer Set	0	0	1	0	0	N2	N1	NO		Status
						0	0	1	Cursor Pointer Set	check
						0	1	0	Offset Register Set	
						1	0	0	Address Pointer Set	
Control Word	0	1	0	0	0	0	N1	NO		32 x 1/fosc
Set Commands							0	0	Text Home Address Set	Diose
Get Commands							0	1	Text Area Set	1
							1	0	Graphic Home Address Set	1
							1	1	Graphic Area Set	1
Mode Set	1	0	0	0	CG	N2	N1	NO		32 x
					0				CC DOM Mada	1/fosc
					0				CG ROM Mode	-
					1	0	0	0	CG RAM Mode "OR" Mode	-
						0	0			-
						0	1	1	"EXOR" Mode "AND" Mode	-
						1	0	0	Text only (attribute capability)	-
Display Modes	1	0	0	1	N3	N2	0 N1	NO	reat only (attribute capability)	32 x
Display Modes	1	0	0	1		NZ	NI	NO		1/fose
					0				Graphics Off	-
					1				Graphics On	4
						0			Text Off	
						1			Text On	1
							0		Cursor Off	4
							1		Cursor On	4
								0	Cursor blink Off	4
								1	Cursor blink On	
Cursor Pattern	1	0	1	0	0	N2	N1	NO	N2~N0: No. of lines for cursor +1	32 x 1/fosc
Select						0	0	0	Bottom Line cursor	
						0	0	1	2 line cursor	1
										1
						1	1	1	8 line cursor (block cursor)	1
Data Auto	1	1	0	0	0	0	N1	N0		32 x
Read/Write							0	0	Data Auto Write Set	1/fosc
Read/ write							0	1	Data Auto Read Set	-
							1	0	Auto reset (Address pointer auto-	-
							1		incremented) for continuous rd/wr	
Data Read/Write	1	1	0	0	0	N2	N1	N0	increased for continuous rus of	-
Data Read Wille	-	-			0	0		110	Address Pointer up/down	1
						1			Address Pointer up/down	1
							0		Address Pointer up	1
							1		Address Pointer down	1
								0	Data Write	1
								1	Data Read	1
Screen Peeking	1	1	1	0	0	0	0	0	Read Displayed Data	Status
Screen Copy	1	1	1	0	1	0	0	0	Copies 1 line of displayed data whose	Status
(Note 3)	1		'		1				address is indicated by the Address	check
(Pointer to Graphic RAM area	
Bit Set/Reset	1	1	1	1	N3	N2	N1	NO	N2~N0 indicates the bit in the pointed	Status
		· 1		•					address	check
					0				Bit Reset	1
					1				Bit Set	1
						0	0	0	Bit 0 (LSB)	1
						0	0	1	Bit 1	1
										1
						1	1	1	Bit 7 (MSB)	1

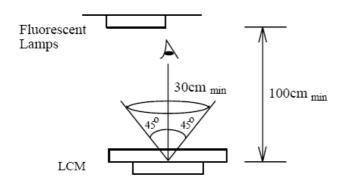
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12.QUALITY SPECIFICATIONS

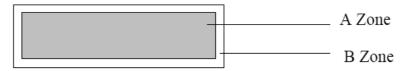
12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area).

B Zone: Non-active display area (outside viewing area).

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AQL inspe Sampling r		ity assurance -105E, Level II, single sampl * is not including)	ing			
Classify		Item		Note	AQL	
Major	Display state	Short or open circuit		1	0.65	
		LC leakage				
		Flickering]		
		No display				
		Wrong viewing direction				
		Contrast defect (dim, ghost)		2		
		Back-light		1,8		
	Non-display	Flat cable or pin reverse		10		
		Wrong or missing componen	nt	11		
Minor	Display	Background color deviation		2	1.0	
	state	Black spot and dust		3		
		Line defect, Scratch		4		
		Rainbow		5		
		Chip		6		
		Pin hole		7		
		Protruded		12		
	Polarizer	Bubble and foreign material		3		
	Soldering	Poor connection		9		
	Wire	Poor connection		10		
	TAB	Position, Bonding strength		13		

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No.	Item			Criterion	
1	Short or open circuit			Not allow	
	LC leakage	-			
	Flickering	-			
	No display	-			
	Wrong viewing direction	-			
	Wrong Back-light	-			
2	Contrast defect		Refer	to approval sa	mple
	Background color deviation	-			
3	Point defect, Black spot, dust	ÛŢĀ	Γ	Point Size	Acceptable Qty.
	(including Polarizer)	X		φ <u><</u> 0.10	Disregard
				0.10<¢≤0.20	3
	$\phi = (X+Y)/2$			0.20<¢≤0.25	2
	¥ ()/-			0.25<¢≤0.30	1
			L	φ>0.30	0
			Unit	:mm	
4	Line defect,	↓ ↓			
4				Line	Acceptable Qty.
	Scratch	$ \begin{array}{c} \overbrace{\scriptstyle{ \leftrightarrow }\\ L} \\ \downarrow \\ L \end{array} W $	L	W	
		L		0.015≥W	Disregard
			3.0≥I 2.0≥I		- 2
			1.0≥I		1
				0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect
			U	Jnit: mm	
5	Rainbow	Not more than tw	o color	changes across	the viewing area.



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Acceptable criterion $ \begin{array}{c} X & Y & \overline{Z} \\ \hline X & Y \\ \hline Z & \hline \\ \hline X & Y \\ \hline Z & \hline \\ \hline X & Y \\ \hline Z & \hline \\ \hline X & Y \\ \hline Z & \hline \\ \hline X & Y \\ \hline Z & \hline \\ \hline \\$
s Acceptable criterion Acceptable criterion X Y Z $\leq 2 0.5 \text{mm} \leq t$ Acceptable criterion X Y Z
X Y Z
$Y \xrightarrow[]{} X \xrightarrow[]{} K \xrightarrow[$
$W_{\underline{y}} \xrightarrow{W_{\underline{y}}} \underbrace{Y}_{\underline{y}} \xrightarrow{V}_{\underline{y}} Z$ Acceptable criterion $X \xrightarrow{Y} Z$ Disregard $\leq 0.2 \leq t$
$\begin{array}{c c} & Y \\ & \swarrow \\ & \swarrow \\ & X \end{array} \xrightarrow{Y} \\ \hline X \\ \end{array} \begin{array}{c} X \\ & X \end{array} \xrightarrow{Acceptable criterion} \\ \hline X \\ \hline X \\ \hline S \\ \hline$

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No.	Item	Criterion
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10$ mm is acceptable.
8	Back-light	 The color of backlight should correspond its specification. Not allow flickering
9	Soldering	 (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land.
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable.
11*	РСВ	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.

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No	Item	Criterion
12	Protruded W: Terminal Width	W V V V $Y \le 0.4$ X
13	ТАВ	1. Position H H H TAB H
		2 TAB bonding strength test F TAB P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	 A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.

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12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	$-20^{\circ}C \leftarrow 25^{\circ}C \rightarrow 70^{\circ}C$	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below $45\pm20\%$ RH), and in the area not exposed to direct sun light. The life time is not content the life time of the LED (for the life time of LED which decay only 50%, in the industry the experience value is 50000 hours, but there are not any experimentation data to support this).

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any

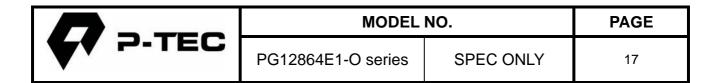
alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting P-tec.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.



- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C±10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

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Limited Warranty

P-tec LCDs and modules are not consumer products, but may be incorporated by P-tec's customers into consumer products or components thereof, P-tec does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of P-tec is limited to repair or replacement on the terms set forth below. P-tec will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between P-tec and the customer, P-tec will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with P-tec general LCD inspection standard . (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.